


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	AMS/22/13762	
1.3 Title of PCN	SOT323 5lds Transfer Qualification in Hefei TF (Assembly & Test)	
1.4 Product Category	See product list	
1.5 Issue date	2022-11-14	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	KRAUSE INA
2.1.2 Phone	+49 89460062370
2.1.3 Email	ina.krause@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Marcello SAN BIAGIO
2.1.2 Marketing Manager	Salvatore DI VINCENZO
2.1.3 Quality Manager	Giuseppe LISI, Jean-Marc BUGNARD

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Product transfer from one site to another site, even if test or process line is qualified	Hefei TF

4. Description of change

	Old	New
4.1 Description	Assembly and Test : - Carsem M	Assembly and Test : - Carsem M - Hefei TF
4.2 Anticipated Impact on form, fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	Additional Assembly and Test Capacity in Hefei TF.
5.2 Customer Benefit	MANUFACTURING FLEXIBILITY

6. Marking of parts / traceability of change

6.1 Description	New finished good codes
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7. Timing / schedule

7.1 Date of qualification results	2022-11-20
7.2 Intended start of delivery	2023-02-15
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	13762 RER 6088-1738-W-2022_New Assembly plant TFME HEFEI for SOT 323 5 LDS.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2022-11-14

9. Attachments (additional documentations)

13762 Public product.pdf
13762 RER 6088-1738-W-2022_New Assembly plant TFME HEFEI for SOT 323 5 LDS.pdf

10. Affected parts		
10.1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	LDK120C33R	
	TSZ121ICT	

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